Surface Mount Diodes Production Process Flow

Solder Paste → Dice Assembled → Soldering → IPA Cleaning

IPQC → Soldering

IPA Cleaning → Epoxy Molding → Aging → Remove Burrs → Trim Form

IPQC → Trim Form

Trim Form → Lead Tin Plating → TMTT Testing → Labeling &Packing → Finished Products Inspection

Visual Inspection → Lead Tin Plating

Finished Products Inspection → Stock Plating → Outgoing Inspection

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